



HCD Announces Availability of Registered DDR DIMM Modules

SUNNYVALE, June 26, 2001 – High Connection Density (HCD) announced today the availability of Registered DDR DIMM memory modules, the latest offering in HCD's extensive DDR line of memory modules. The HCD line offers modules in either PC1600 or PC2100 speed grades, with module densities ranging from 128MB up to 1GB, using x4, x8 or x16 devices. All HCD Registered DDR configurations conform to the JEDEC standard.

"HCD has always been an active JEDEC member and supporter," stated Desi Rhoden, President and CEO of AMI2. "HCD's introduction of Registered DDR DIMM products will help to ensure the success and adoption of DDR technology in the storage, server and networking markets." Targeted for server and network markets, HCD's DDR modules offer the high memory capacity and bandwidth needed to stay in step with the constantly increasing performance of these systems.

"The DDR SDRAM market is poised to expand quickly in the next year as new end use products reach production," said Sherri Garber, research analyst at Semico Research Corporation. "DDR SDRAM was a mere 1 percent of the DRAM market in 2000. It is projected to be 11 percent of the units shipped in 2001 and 32 percent of shipments in 2002. DRAM unit shipments in 2001 for the total market will be 4.0 billion units. DDR SDRAM is forecast to be 453 million this year."

HCD's expertise in high frequency technologies such as Direct Rambus™ RIMMs and SO-RIMMs has demonstrated its manufacturing capacity for high reliability and performance products. HCD is currently developing modular memory subsystems extending both Rambus and DDR technologies beyond the standard and small outline memory module form factors, to enable sub-1U rack-mount systems for release in 2001.

About the company:

High Connection Density Inc. (HCD) is a premier supplier of advanced memory modules and high performance modular subsystems. Focusing on modular solutions enabling the transition to next generation systems, HCD's expertise in packaging, thermal and mechanical design, and manufacturing position HCD to be a premier source of modular subsystems and solutions for high performance electronic applications. To learn more about HCD products and services, visit the website at www.hcdcorp.com.

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